National Semiconductor

LM2991 Negative Low Dropout Adjustable Regulator

General Description

The LM2991 is a low dropout adjustable negative regulator with a output voltage range between -3V to -24V. The LM2991 provides up to 1A of load current and features a On /Off pin for remote shutdown capability.

The LM2991 uses new circuit design techniques to provide a low dropout voltage, low quiescent current and low temperature coefficient precision reference. The dropout voltage at 1A load current is typically 0.6V and a guaranteed worst-case maximum of 1V over the entire operating temperature range. The quiescent current is typically 1 mA with a 1A load current and an input-output voltage differential greater than 3V. A unique circuit design of the internal bias supply limits the quiescent current to only 9 mA (typical) when the regulator is in the dropout mode ($V_{OUT} - V_{IN} \le 3V$).

The LM2991 is short-circuit proof, and thermal shutdown includes hysteresis to enhance the reliability of the device when inadvertently overloaded for extended periods. The LM2991 is available in 5-lead TO-220 and TO-263 packages and is rated for operation over the automotive temperature range of -40° C to $+125^{\circ}$ C. Mil-Aero versions are also available.

Features

- Output voltage adjustable from -3V to -24V, typically -2V to -25V
- Output current in excess of 1A
- Dropout voltage typically 0.6V at 1A load
- Low quiescent current
- Internal short circuit current limit
- Internal thermal shutdown with hysteresis
- TTL, CMOS compatible ON/OFF switch
- Functional complement to the LM2941 series

Applications

- Post switcher regulator
- Local, on-card, regulation
- Battery operated equipment

Typical Application R1 240 Co** Cin* 10 µF 10 µF GND ADJ R2 VIN Regulated Unregulated LM2991 Output Input ON/OFF DS011260-1

$V_{OUT} = V_{REF} (1 + R2/R1)$

*Required if the regulator is located further than 6 inches from the power supply filter capacitors. A 1 µF solid tantalum or a 10 µF aluminum electrolytic capacitor is recommended.

**Required for stability. Must be at least a 10 μ F aluminum electrolytic or a 1 μ F solid tantalum to maintain stability. May be increased without bound to maintain regulation during transients. Locate the capacitor as close as possible to the regulator. The equivalent series resistance (ESR) is critical, and should be less than 10 Ω over the same operating temperature range as the regulator.

Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/ Distributors for availability and specifications.

Storage Temperature Range Lead Temperature (Soldering, 10 sec.) -65°C to +150°C 230°C

Operating Ratings (Note 1)

Input Voltage	-26V to +0.3V
ESD Susceptibility (Note 2)	2 kV
Power Dissipation (Note 3)	Internally limited
Junction Temperature (T _{Jmax})	125°C

Junction Temperature Range (T_J) Maximum Input Voltage (Operational)

-40°C to +125°C -26V

Electrical Characteristics

$V_{IN} = -10V$, $V_O = -3V$, $I_O = 1A$, $C_O = 47 \ \mu$ F, R1 = 2.7k, $T_J = 25^{\circ}$ C, unless otherwise specified. Boldface limits	apply over
the entire operating junction temperature range.	

Parameter	Conditions	Typical (Note 4)	Min	Max	Units
Reference Voltage	$5 \text{ mA} \le I_{O} \le 1 \text{A}$	-1.210	-1.234	-1.186	V
	$5 \text{ mA} \le I_{O} \le 1\text{A},$		-1.27	-1.15	V
	$V_O - 1V \ge V_{IN} \ge -26V$				
Output Voltage		-2		-3	V
Range	$V_{IN} = -26V$	-25	-24		V
Line Regulation	$I_{O} = 5 \text{ mA}, V_{O} - 1V \ge V_{IN} \ge -26V$	0.004		0.04	%/V
Load Regulation	$50 \text{ mA} \le I_O \le 1\text{A}$	0.04		0.4	%
Dropout Voltage	$I_{O} = 0.1A, \Delta V_{O} \le 100 \text{ mV}$	0.1		0.2	V
				0.3	
	I_{O} = 1A, $\Delta V_{O} \le 100 \text{ mV}$	0.6		0.8	V
				1	
Quiescent Current	I _O ≤ 1A	0.7		5	mA
Dropout Quiescent	$V_{IN} = V_O, I_O \le 1A$	16		50	mA
Current					
Ripple Rejection	$V_{ripple} = 1 Vrms, f_{ripple} = 1 kHz,$	60	50		dB
	$I_{O} = 5 \text{ mA}$				
Output Noise	10 Hz – 100 kHz, I _O = 5 mA	200		450	μV
ON /OFF Input	(V _{OUT} : ON)	1.2		0.8	V
Voltage	(V _{OUT} : OFF)	1.3	2.4		
ON /OFF Input	$V_{ON/OFF} = 0.8V (V_{OUT}: ON)$	0.1		10	μΑ
Current	$V_{ON/OFF} = 2.4V (V_{OUT}: OFF)$	40		100	
Output Leakage	$V_{IN} = -26V, V_{ON/OFF} = 2.4V$	60		250	μΑ
Current	$V_{OUT} = 0V$				
Current Limit	V _{OUT} = 0V	2	1.5		A

Note 1: Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is intended to be functional, but do not guarantee specific performance limits. For guaranteed specifications and test conditions, see the Electrical Characteristics. Note 2: Human body model, 100 pF discharged through a 1.5 $k\Omega$ resistor.

Note 3: The maximum power dissipation is a function of T_{Jmax}, θ_{JA} and T_A. The maximum allowable power dissipation at any ambient temperature is P_D = (T_{Jmax}) - T_A)/θ_{JA}. If this dissipation is exceeded, the die temperature will rise above 125°C and the LM2991 will go into thermal shutdown. For the LM2991, the

junction-to-ambient thermal resistance is 3°C/W for the TO-220, 73°C/W for the TO-263, and junction-to-case thermal resistance is 3°C. If the TO-263 package is used, the thermal resistance can be reduced by increasing the PC board copper area thermally connected to the package. Using 0.5 square inches of copper area, θ_{JA} is 50°C/W; with 1 square inch of copper area, θ_{JA} is 37°C/W; and with 1.6 or more square inches of copper area, θ_{JA} is 32°C/W.

Note 4: Typicals are at $T_J = 25^{\circ}C$ and represent the most likely parametric norm.

